

## Maximum Ratings @T<sub>A</sub> = 25°C unless otherwise specified

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage	V <sub>RRM</sub> V <sub>RWM</sub>	100	V
Forward Continuous Current (Note 5)	I <sub>FM</sub>	300	mA
Non-Repetitive Peak Forward Surge Current @ t = 1.0 @ t = 1.0	leon.	2.0 1.0	А

### **Thermal Characteristics**

Characteristic	Symbol	Value	Unit
Power Dissipation (Note 5)	$P_{D}$	350	mW
Thermal Resistance Junction to Ambient Air (Note 5)	R <sub>OJA</sub>	357	°C/W
Operating and Storage Temperature Range	$T_J,T_STG$	-65 to +150	°C

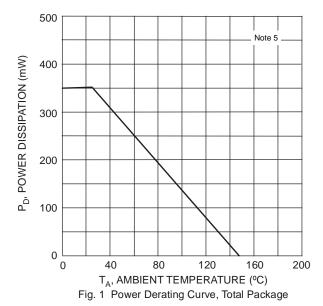
# Electrical Characteristics @T<sub>A</sub> = 25°C unless otherwise specified

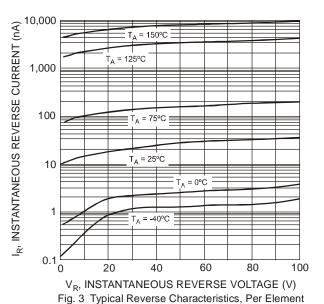
Characteristic	Symbol	Min	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 6)	$V_{(BR)R}$	100		V	$I_R = 100\mu A$
Forward Voltage	V <sub>F</sub>	0.55 0.67 0.75 —	0.70 0.82 1.10 1.25	V	I <sub>F</sub> = 1.0mA I <sub>F</sub> = 10mA I <sub>F</sub> = 50mA I <sub>F</sub> = 150mA
Reverse Current (Note 6)	I <sub>R</sub>	_	1.0 3.0 100 25		$V_R = 50V$ $V_R = 100V$ $V_R = 50V$ , $T_J = 125$ °C $V_R = 20V$
Total Capacitance	C <sub>T</sub>	_	2.0	pF	$V_R = 0, f = 1.0MHz$
Reverse Recovery Time	t <sub>rr</sub>	_	4.0	ns	$I_F = I_R = 10 \text{mA},$ $I_{rr} = 0.1 \times I_R, R_L = 100 \Omega$

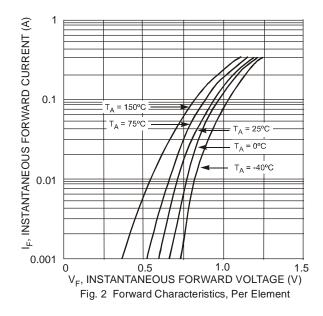
Notes:

- 5. Part mounted on FR-4 substrate printed circuit board with 1 inch square 2oz copper pad area.
- 6. Short duration pulse test used to minimize self-heating effect.









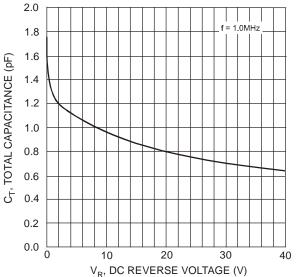
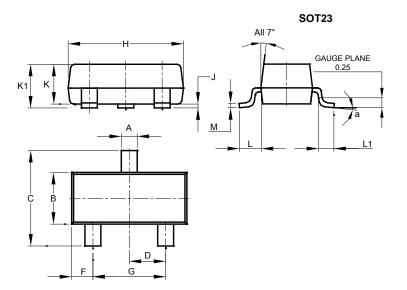


Fig. 4 Total Capacitance vs. Reverse Voltage, Per Element



### **Package Outline Dimensions**

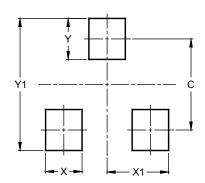
Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23			
Dim	Min	Max	Тур
Α	0.37	0.51	0.40
В	1.20	1.40	1.30
С	2.30	2.50	2.40
D	0.89	1.03	0.915
F	0.45	0.60	0.535
G	1.78	2.05	1.83
Н	2.80	3.00	2.90
J	0.013	0.10	0.05
K	0.890	1.00	0.975
K1	0.903	1.10	1.025
L	0.45	0.61	0.55
L1	0.25	0.55	0.40
М	0.085	0.150	0.110
а	0°	8°	
All Dimensions in mm			

### **Suggested Pad Layout**

Please see http://www.diodes.com/package-outlines.html for the latest version.



SOT23

Dimensions	Value (in mm)
C	2.0
Х	0.8
X1	1.35
Y	0.9
Y1	2.9



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